

# HSP

**NOTES:**

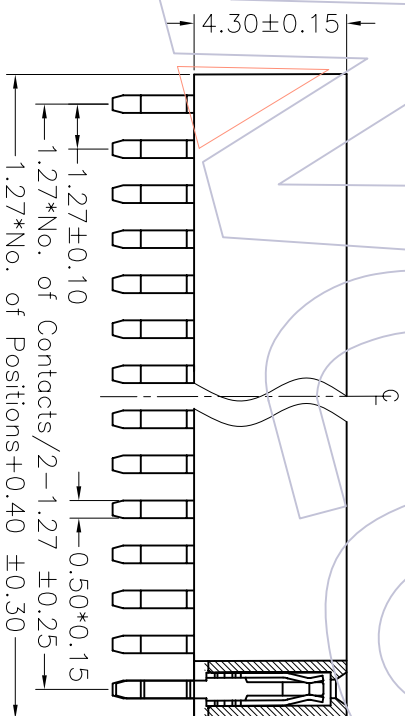
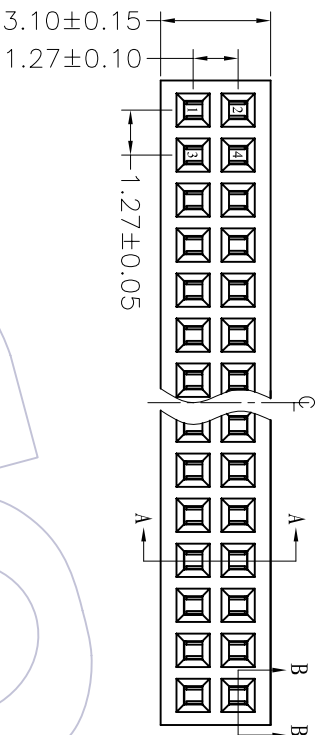
- Current Rating: 1.0AMP
- Withstand Voltage: 500V AC/DC
- Contact Resistance: 20mΩ Max
- Insulation Resistance: 1000MΩMin
- Operation Temperature: -40°C to +105°C
- Contact Material: Phosphor Bronze
- Contact plating: Au or Sn over Ni
- Insulator Material: PA6T+30%G. F UL94V-0

## Ordering Information

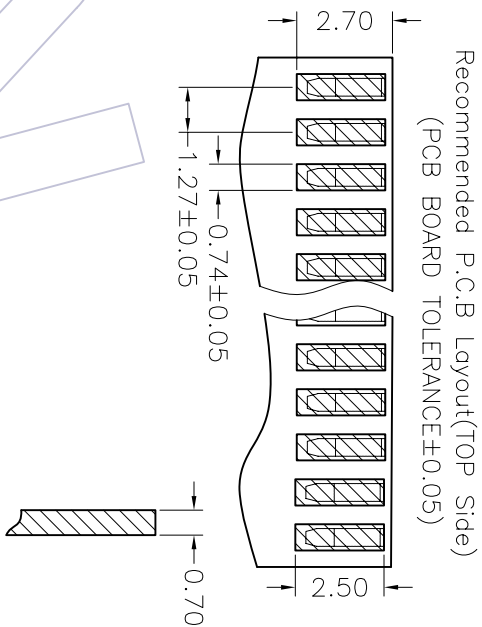
2344 - 2 XX C XX CUNT 1

No. of Pins per Row: 52-50Pin

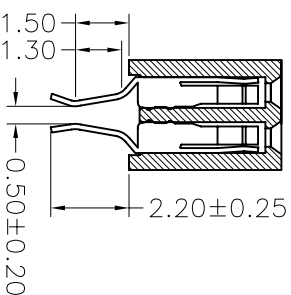
- Contact Plating: T=Tube
- GF=Gold Flash
- G1=3μ Gold
- G2=5μ Gold
- G3=10μ Gold
- G4=15μ Gold
- G5=30μ Gold
- SP=Gold Flash/Tin
- S1=3μ Gold/Tin
- S2=5μ Gold/Tin
- S3=10μ Gold/Tin
- S4=15μ Gold/Tin
- S5=30μ Gold/Tin
- SN=Tin



SECTION B-B



Recommended P.C.B Layout(TOP Side)  
(PCB BOARD TOLERANCE±0.05)



SECTION A-A

| REV | DATE     | MODIFICATION DESCRIPTION | CHANGE | APPROVE | OPERATION                                    | DRAW            | SCALE           | PART NO.         | TITLE:                       |
|-----|----------|--------------------------|--------|---------|--|-----------------|-----------------|------------------|------------------------------|
| A0  | 08/02/16 | NEW                      |        |         | XXX<br>±0.40<br>XXX<br>±0.25<br>XXX<br>±0.15 | DESIGN<br>CHECK | 3:1<br>mm<br>A4 | 2344-2XXCXXCUNT1 | PH1.27mm DUAL SPLINT H=4.3mm |
| REV | DATE     | MODIFICATION DESCRIPTION | CHANGE | APPROVE | Angle<br>DIM                                 | CHECK           | PROJ.           | Customer NO.     |                              |

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